

### PRECISION AUDIO CLOCK SOURCE

**ICS661** 

## **Description**

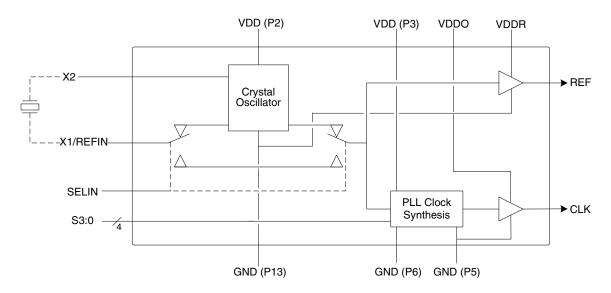
The ICS661 provides synchronous clock generation for audio sampling clock rates derived from an MPEG stream, or can be used as a standalone clock source with a 27 MHz crystal. The device uses the latest PLL technology to provide excellent phase noise and long term jitter performance for superior synchronization and S/N ratio.

Please contact IDT if you have a requirement for an input and output frequency not included here - we can rapidly modify this product to meet special requirements.

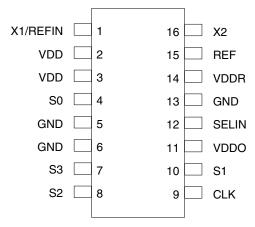
### **Features**

- Packaged in 16-pin TSSOP
- Pb (lead) free package, RoHS compliant
- · Clock or crystal input
- · Low phase noise
- · Low jitter
- Exact (0 ppm) multiplication ratios
- · Reference clock output available
- Support for 256, 384, 512, and 768 times sampling rate

## **Block Diagram**



# **Pin Assignment**



16-pin 4.40 mil body, 0.50 mm pitch TSSOP

# **Output Clock Selection Table**

<b>S</b> 3	S2	S1	S0	Input Frequency (MHz)	Output Frequency (MHz)
0	0	0	0	27	8.192
0	0	0	1	27	11.2896
0	0	1	0	27	12.288
0	0	1	1	27	24.576
0	1	0	0	27	12.288
0	1	0	1	27	16.9344
0	1	1	0	27	18.432
0	1	1	1	27	36.864
1	0	0	0	27	16.384
1	0	0	1	27	22.5792
1	0	1	0	27	24.576
1	0	1	1	27	49.152
1	1	0	0	27	24.576
1	1	0	1	27	33.8688
1	1	1	0	27	36.864
1	1	1	1	27	73.728

# **Pin Descriptions**

Pin Number	Pin Name	Pin Type	Pin Description			
1	X1/REFIN	Input	Connect this pin to a crystal or clock input			
2	VDD	Power	Power supply for crystal oscillator.			
3	VDD	Power	Power supply for PLL.			
4	S0	Input	Output frequency selection. Determines output frequency per table above. On chip pull-up.			
5	GND	Power	Connect to ground.			
6	GND	Power	Ground for output stage.			
7	S3	Input	Output frequency selection. Determines output frequency per table above. On chip pull-up.			
8	S2	Input	Output frequency selection. Determines output frequency per table above. On chip pull-up.			
9	CLK	Output	Clock output.			
10	S1	Input	Output frequency selection. Determines output frequency per table above. On chip pull-up.			
11	VDDO	Power	Power supply for output stage.			
12	SELIN	Input	Low for clock input, high for crystal. On chip pull-up.			
13	GND	Power	Connect to ground.			
14	VDDR	Power	Power supply for reference output. Ground to turn off REF.			
15	REF	Output	Reference clock output.			
16	X2	Input	Connect this pin to a crystal. Leave open if using a clock input.			

### **Application Information**

### **Series Termination Resistor**

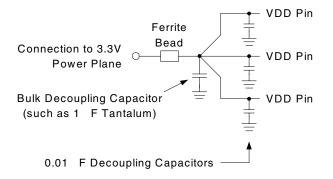
Clock output traces should use series termination. To series terminate a  $50\Omega$  trace (a commonly used trace impedance), place a  $33\Omega$  resistor in series with the clock line, as close to the clock output pin as possible. The nominal impedance of the clock output is  $20\Omega$ 

### **Decoupling Capacitors**

As with any high performance mixed-signal IC, the ICS661 must be isolated from system power supply noise to perform optimally.

Decoupling capacitors of  $0.01\mu F$  must be connected between each VDD and the PCB ground plane. To further guard against interfering system supply noise, the ICS661 should use one common connection to the PCB power plane as shown in the diagram on the next page. The ferrite bead and bulk capacitor help reduce lower frequency noise in the supply that can lead to output clock phase modulation.

### Recommended Power Supply Connection for Optimal Device Performance



All power supply pins must be connected to the same voltage, except VDDR and VDDO may be connected to a lower voltage in order to change the output level. If the reference output is not used, ground VDDR.

#### **Crystal Load Capacitors**

If a crystal is used, the device crystal connections should include pads for capacitors from X1 to ground and from X2 to ground. These capacitors are used to adjust the stray

capacitance of the board to match the nominally required crystal load capacitance. To reduce possible noise pickup, use very short PCB traces (and no vias) been the crystal and device.

The value of the load capacitors can be roughly determined by the formula C = 2(C<sub>L</sub> - 6) where C is the load capacitor connected to X1 and X2, and C<sub>L</sub> is the specified value of the load capacitance for the crystal. A typical crystal C<sub>L</sub> is 18 pF, so C = 2(18 - 6) = 24 pF. Because these capacitors adjust the stray capacitance of the PCB, check the output frequency using your final layout to see if the value of C should be changed.

### **PCB Layout Recommendations**

For optimum device performance and lowest output phase noise, the following guidelines should be observed.

- 1) Each 0.01µF decoupling capacitor should be mounted on the component side of the board as close to the VDD pin as possible. No vias should be used between decoupling capacitor and VDD pin. The PCB trace to VDD pin should be kept as short as possible, as should the PCB trace to the ground via. Distance of the ferrite bead and bulk decoupling from the device is less critical.
- 2) The external crystal should be mounted next to the device with short traces. The X1 and X2 traces should not be routed next to each other with minimum spaces, instead they should be separated and away from other traces.
- 3) To minimize EMI and obtain the best signal integrity, the  $33\Omega$  series termination resistor should be placed close to the clock output.
- 4) An optimum layout is one with all components on the same side of the board, minimizing vias through other signal layers (the ferrite bead and bulk decoupling capacitor can be mounted on the back). Other signal traces should be routed away from the ICS661. This includes signal traces just underneath the device, or on layers adjacent to the ground plane layer used by the device.

## **Absolute Maximum Ratings**

Stresses above the ratings listed below can cause permanent damage to the ICS661. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

Item	Rating
Supply Voltage, VDD	5.5 V
All Inputs and Outputs	-0.5 V to VDD+0.5 V
Ambient Operating Temperature	-40 to +85° C
Storage Temperature	-65 to +150° C
Junction Temperature	125° C
Soldering Temperature	260° C

## **Recommended Operation Conditions**

Parameter	Min.	Тур.	Max.	Units
Ambient Operating Temperature	-40		+85	°C
Power Supply Voltage (measured in respect to GND)	+3.0		+3.6	V

### **DC Electrical Characteristics**

Unless stated otherwise, VDD = 3.3 V ±10%, Ambient Temperature -40 to +85° C

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Operating Voltage	VDD		3.0		3.6	V
	VDDO		1.8		VDD	V
	VDDR		1.8		VDD	V
Input High Voltage	V <sub>IH</sub>		2			V
Input Low Voltage	V <sub>IL</sub>				8.0	V
Output High Voltage	V <sub>OH</sub>	I <sub>OH</sub> = -4 mA	VDD-0.4			V
Output High Voltage	V <sub>OH</sub>	I <sub>OH</sub> = -20 mA	2.4			V
Output Low Voltage	V <sub>OL</sub>	I <sub>OL</sub> = 20 mA			0.4	V
Supply Current	IDD	No Load		25		mA
Short Circuit Current	Ios	Each output		±65		mA
Nominal Output Impedance	Z <sub>OUT</sub>			20		Ω
Input Capacitance		Input pins		7		pF
Internal Pull-up Resistor				120		kΩ

## **AC Electrical Characteristics**

Unless stated otherwise, **VDD = 3.3 V ±10%**, Ambient Temperature -40 to +85° C

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Crystal Frequency				27	28	MHz
Output Clock Rise Time	t <sub>OR</sub>	20% to 80%, 15 pF load			1.5	ns
Output Clock Fall Time	t <sub>OF</sub>	80% to 20%, 15 pF load			1.5	ns
Output Duty Cycle	t <sub>OD</sub>	At VDD/2, 15 pF load	45	49 to 51	55	%
Jitter, Short term		Reference clock off		175		ps p-p
Jitter, Short term		Reference clock on		175		ps p-p
Jitter, Long term		Reference clock off; 10 us delay		300		ps p-p
Jitter, Long term		Reference clock on; 10 us delay		300		ps p-p
Single Sideband Phase Noise		Reference clock off; 10 kHz offset		-110		dBc
Single Sideband Phase Noise		Reference clock on; 10 kHz offset		-110		dBc
Actual Mean Frequency Error versus Target				0		ppm

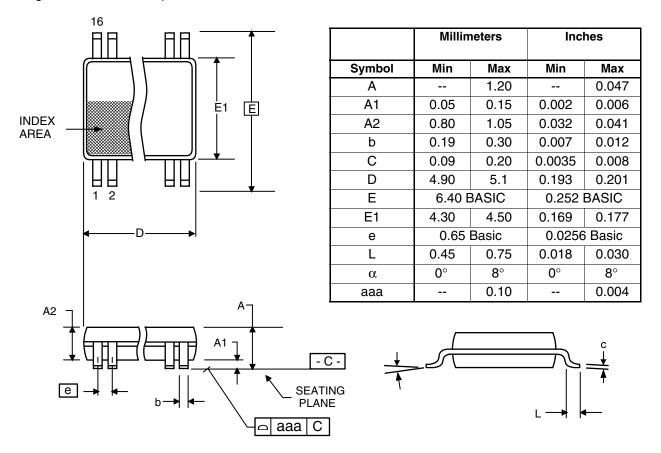
## **Thermal Characteristics**

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Thermal Resistance Junction to	$\theta_{JA}$	Still air		78		° C/W
Ambient	$\theta_{JA}$	1 m/s air flow		70		° C/W
	$\theta_{JA}$	3 m/s air flow		68		° C/W
Thermal Resistance Junction to Case	$\theta_{JC}$			37		° C/W

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### Package Outline and Package Dimensions (16-pin TSSOP, 4.40 mm Body, 0.65 mm Pitch)

Package dimensions are kept current with JEDEC Publication No. 95, MO-153



# **Ordering Information**

Part / Order Number	Order Number Marking Shipping Packagi		Package	Temperature	
661GILF	661GILF	Tubes	16-pin TSSOP	-40 to +85° C	
661GILFT	661GILF	Tape and Reel	16-pin TSSOP	-40 to +85° C	

#### "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

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